

# DC Input 4-Pin Phototransistor Optocoupler

#### **Features**

- High isolation 5000 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range 55 ℃ to 110 ℃
- Regulatory Approvals
  - UL UL1577 (E364000)
  - VDE EN60747-5-5(VDE0884-5)
  - CQC GB4943.1, GB8898
  - IEC60065, IEC60950

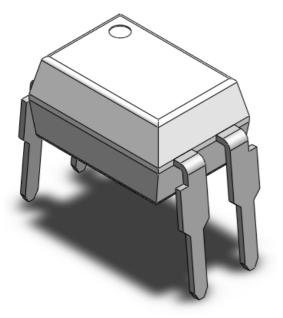
### **Applications**

- Switch mode power supplies
- Computer peripheral interface
- Microprocessor system interface

### **Description**

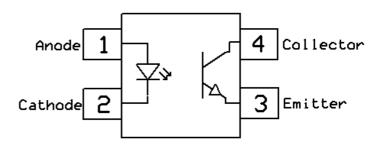
The CT817 series consists of a photo transistor optically coupled to a gallium arsenide Infrared-emitting diode in a 4-lead DIP package different lead forming options.

## **Package Outline**



# Note: Different lead forming options available. See package dimension.

### **Schematic**





# **DC Input 4-Pin Phototransistor Optocoupler**

## Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
Viso	Isolation voltage	5000	V <sub>RMS</sub>	
Ртот	Total power dissipation	200	mW	
Topr	Operating temperature	-55 ~ +110	°C	
Тѕтс	Storage temperature	-55 ~ +150	°C	
TsoL	Soldering temperature	260	°C	
Emitter				
l <sub>F</sub>	Forward current	60	mA	
I <sub>F(TRANS)</sub>	Peak transient current (≤1µs P.W,300pps)	1	Α	
V <sub>R</sub>	Reverse voltage	6	V	
P <sub>D</sub>	Emitter power dissipation	100	mW	
Detector				
P <sub>D</sub>	Detector power dissipation	150	mW	
Bvceo	Collector-Emitter Breakdown Voltage	35	٧	
Bveco	Emitter-Collector Breakdown Voltage	6	V	
Ic	Collector Current	50	mA	



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### **Electrical Characteristics** $T_A = 25 \, ^{\circ}\text{C}$ (unless otherwise specified)

#### **Emitter Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	I <sub>F</sub> =10mA		1.2	1.4	٧	
IR	Reverse Current	$V_R = 6V$	-	-	5	μΑ	
C <sub>IN</sub>	Input Capacitance	f= 1MHz	-	30	-	pF	

#### **Detector Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
Bvceo	Collector-Emitter Breakdown	I <sub>C</sub> = 100μA	35	-	-	V	
Bveco	Emitter-Collector Breakdown	Breakdown I <sub>E</sub> = 1mA		-	-	V	
ICEO	Collector-Emitter Dark Current	V <sub>CE</sub> = 20V, I <sub>F</sub> =0mA	-	-	100	nA	

#### **Transfer Characteristics**

Symbol	Parameters		Test Conditions	Min	Тур	Max	Units	Notes
	Current Transfer Ratio CT	CT817	IF= 5mA, VCE= 5V	50		600	%	
		CT817A		80		160		
CTR		CT817B		130		260		
		CT817C		200		400		
		CT817D		300		600		
Various	Collector-Emitter Saturation		I <sub>F</sub> = 20mA, I <sub>C</sub> = 1mA		0.1	0.2	V	
V <sub>CE(SAT)</sub>	Voltage		IF= 20IIIA, IC= IIIIA	-	0.1	0.2	V	
R <sub>IO</sub>	Isolation Resistance		V <sub>IO</sub> = 500V <sub>DC</sub>	5x10 <sup>10</sup>				
Cıo	Isolation Capacitance		f= 1MHz		0.5	1	pF	

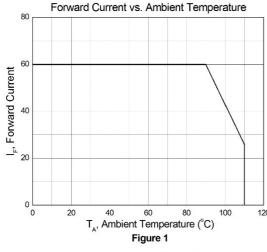
### **Switching Characteristics**

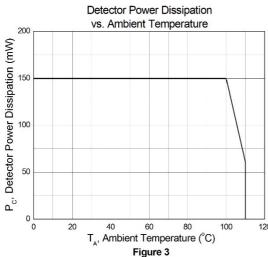
Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
tr	Rise Time	la 2m/ Var 2V B. 100	-	6	-		
t <sub>f</sub>	Fall Time	Ic= 2mA, V <sub>CE</sub> = 2V, R <sub>L</sub> = 100	-	8	-	μS	

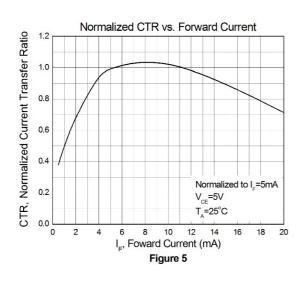


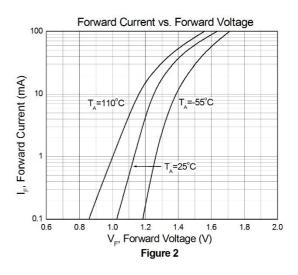
# DC Input 4-Pin Phototransistor Optocoupler

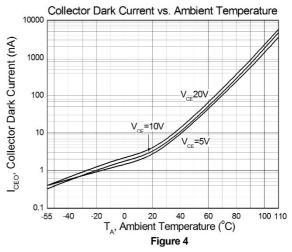
# **Typical Characteristic Curves**

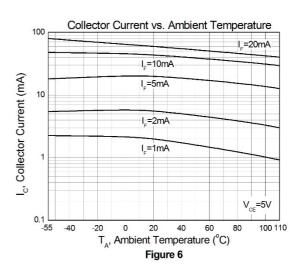






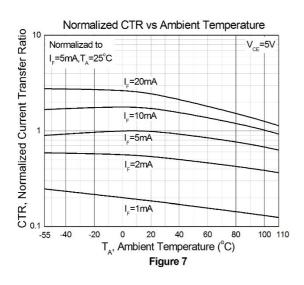


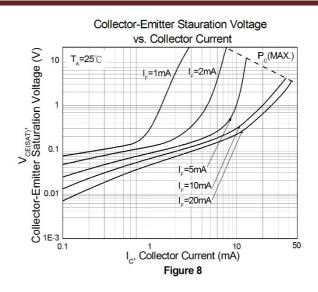


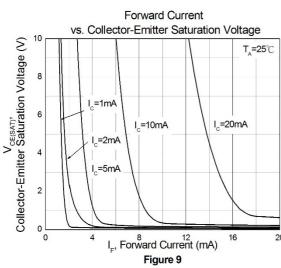


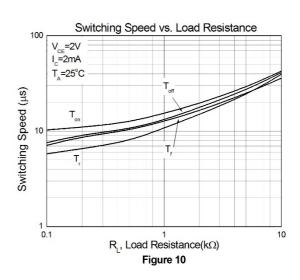


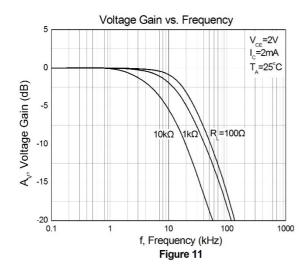
# DC Input 4-Pin Phototransistor Optocoupler





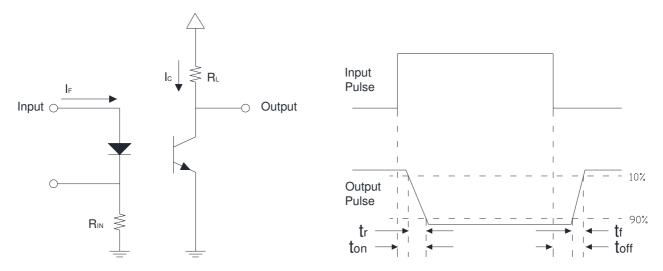








### **Test Circuit**



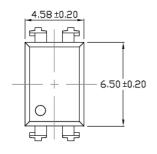
**Figure 12: Switching Time Test Circuits** 

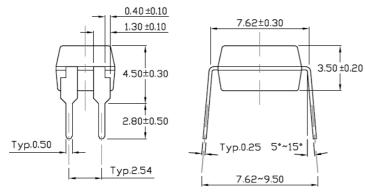




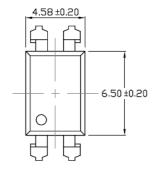
#### Package Dimension Dimensions in mm unless otherwise stated

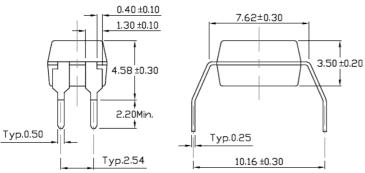
#### Standard DIP - Through Hole

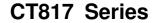




### Gullwing (400mil) Lead Forming – Through Hole (M Type)

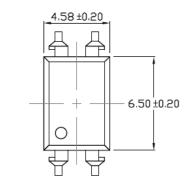


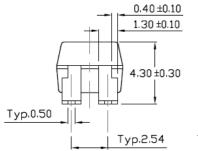


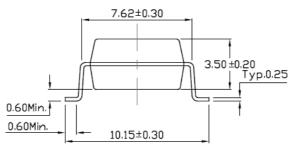




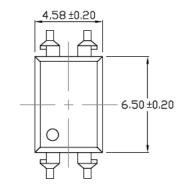
### **Surface Mount Lead Forming (S Type)**

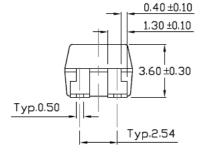


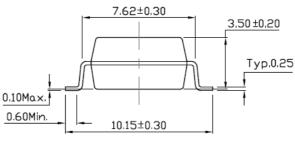




#### Surface Mount (Low Profile) Lead Forming (SL Type)



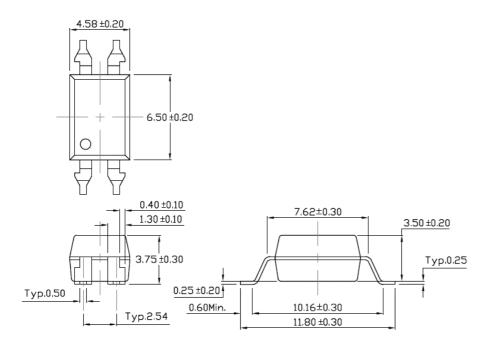


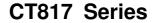




# **DC Input 4-Pin Phototransistor Optocoupler**

### **Surface Mount (Gullwing) Lead Forming (SLM Type)**

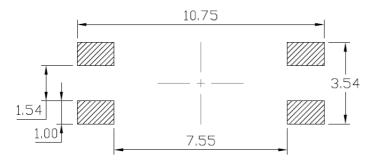




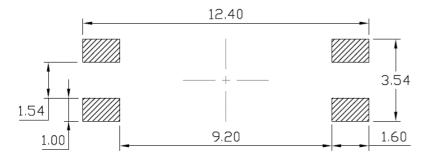


#### Recommended Solder Mask Dimensions in mm unless otherwise stated

#### Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming



#### **Surface Mount (Gullwing) Lead Forming**



## **Marking Information**



#### Note:

CT : Denotes "CT Micro"

817 : Part NumberV : VDE OptionR : CTR RankY : Fiscal YearWW : Work Week

K : Manufacturing Code





### **Ordering Information**

CT817X(V)(Y)(Z)-HG

X = Part No. (X=A, B, C, D or None)

V = VDE Option (V or None)

Y = Lead form option (S, SL, M, SLM or none)

Z = Tape and reel option (T1, T2, T3, T4 or none)

H = Lead frame option (H: Iron, None: Copper)

G= Material option (G: Green, None: Non-green)

Option	Description	Quantity
None	Standard 4 Pin Dip	100 Units/Tube
М	Gullwing (400mil) Lead Forming	100 Units/Tube
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1500 Units/Reel
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1500 Units/Reel
S(T3)	Surface Mount Lead Forming – With Option 3 Taping	1000 Units/Reel
S(T4)	Surface Mount Lead Forming – With Option 4 Taping	1000 Units/Reel
SL(T1)	Surface Mount (Low Profile) Lead Forming– With Option 1 Taping	1500 Units/Reel
SL(T2)	Surface Mount (Low Profile) Lead Forming – With Option 2 Taping	1500 Units/Reel
SL(T3)	Surface Mount (Low Profile) Lead Forming- With Option 3 Taping	1000 Units/Reel
SL(T4)	Surface Mount (Low Profile) Lead Forming – With Option 4 Taping	1000 Units/Reel
SLM(T1)	Surface Mount (Gullwing) Lead Forming- With Option 1 Taping	1500 Units/Reel
SLM(T2)	Surface Mount (Gullwing) Lead Forming – With Option 2 Taping	1500 Units/Reel

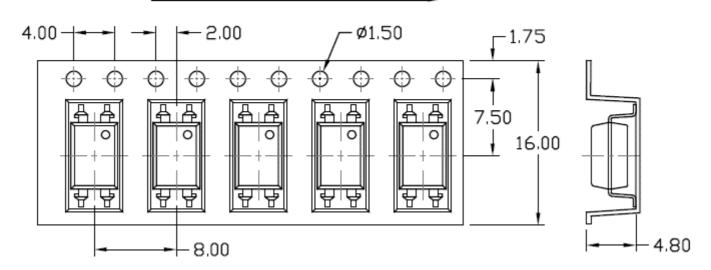


# DC Input 4-Pin Phototransistor Optocoupler

# Carrier Tape Specifications Dimensions in mm unless otherwise stated

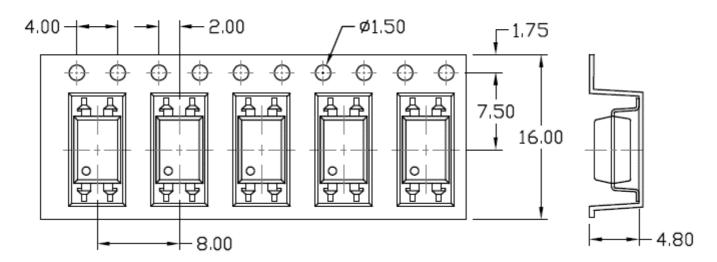
Option S(T1) & SL(T1)

# Input Direction



### Option S(T2) & SL(T2)

# Input Direction

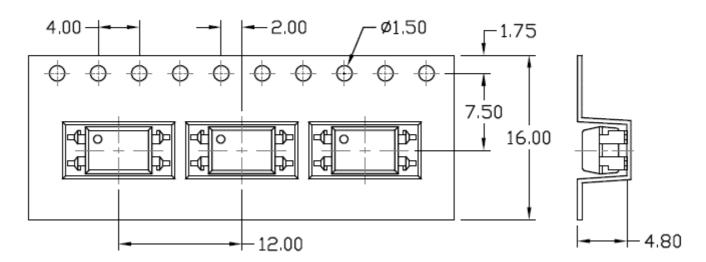




# DC Input 4-Pin Phototransistor Optocoupler

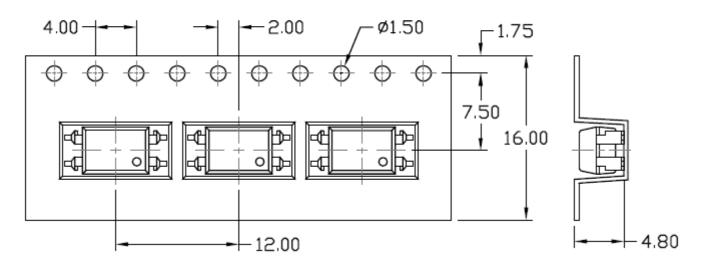
## Option S(T3) & SL(T3)

# Input Direction



## Option S(T4) & SL(T4)

# Input Direction

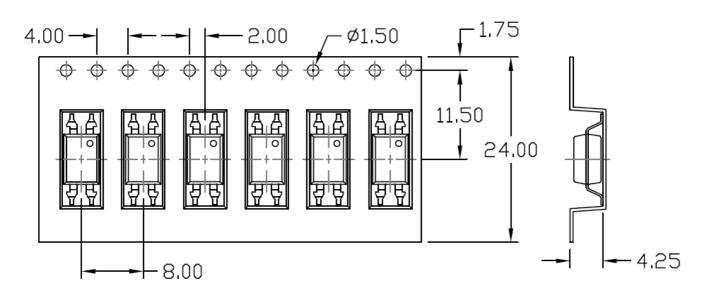




# DC Input 4-Pin Phototransistor Optocoupler

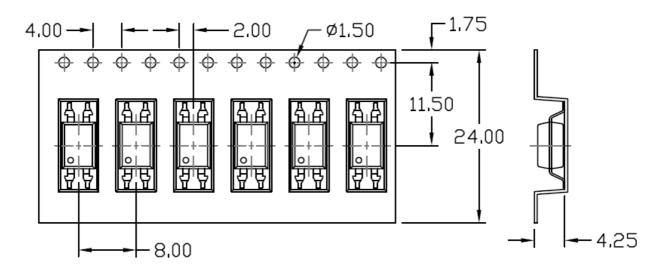
### Option SLM(T1)

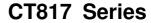
# Input Direction



#### **Option SLM(T2)**

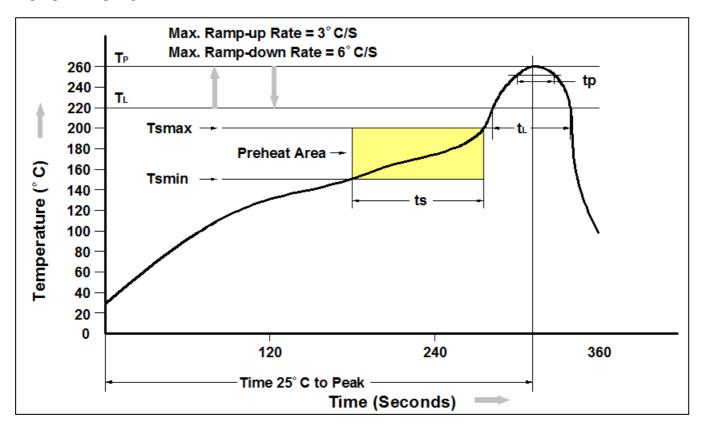
# Input Direction







### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile		
Temperature Min. (Tsmin)	150℃		
Temperature Max. (Tsmax)	200℃		
Time (ts) from (Tsmin to Tsmax)	60-120 seconds		
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.		
Liquidous Temperature (T <sub>L</sub> )	217℃		
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds		
Peak Body Package Temperature	260℃ +0℃ / -5℃		
Time (t <sub>P</sub> ) within 5 °C of 260 °C	30 seconds		
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max		
Time 25 ℃ to Peak Temperature	8 minutes max.		



# DC Input 4-Pin Phototransistor Optocoupler

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